

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5541451

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YOSHINOBU SHIMADA	04/05/2019
HIROTAKE KANEKO	04/05/2019
RECEIVING PARTY DATA	
Name:	DAI-ICHI SEIKO CO.,LTD.
Street Address:	12-4 NEGORO, MOMOYAMA-CHO, FUSHIMI-KU
City:	KYOTO-SHI, KYOTO
State/Country:	JAPAN
Postal Code:	612-8024
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16367263
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-945-1064
Email:	uspto@soei-patent.co.jp
Correspondent Name:	SOEI PATENT & LAW FIRM
Address Line 1:	1001 19TH STREET NORTH, SUITE 1200
Address Line 4:	ARLINGTON, VIRGINIA 22209
ATTORNEY DOCKET NUMBER:	FP19-0069-00US-DSK
NAME OF SUBMITTER:	BRYAN D. KIRKPATRICK
SIGNATURE:	/Bryan D. Kirkpatrick/
DATE SIGNED:	05/28/2019
Total Attachments: 1	
source=Assignment_FP19-0069-00US-DSK#page1.tif	

ASSIGNMENTWhereas, I/we,
NameAddress1) **Yoshinobu SHIMADA**c/o DAI-ICHI SEIKO Co., Ltd.,
863 Mitsusawa,
Ogori-shi, Fukuoka 838-0106 Japan2) **Hirotake KANEKO**c/o DAI-ICHI SEIKO Co., Ltd.,
863 Mitsusawa,
Ogori-shi, Fukuoka 838-0106 Japanhereinafter called assignor(s), have invented certain improvements in
ELECTRICAL CONNECTORand executed an application for Letters Patent of the United States of America therefor on even date herewith unless
otherwise indicated below:filed on March 28, 2019, Serial No. 16/367263; and

Whereas

DAI-ICHI SEIKO CO.,LTD.

12-4 Negoro, Momoyama-cho, Fushimi-ku,
Kyoto-shi, Kyoto 612-8024 Japan(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States
patents to be obtained therefor;

NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and

In the event that the patent application filing date or serial number is not known at the time this Assignment is executed, I/WE hereby grant permission to the attorneys of record in the patent application to fill in the filing date and/or serial number above, and to record this Assignment after such information is added.

INVENTORSDATE SIGNED

1):

Yoshinobu SHIMADA

Name :

Yoshinobu SHIMADA

2):

Hirotake KANEKO

Name :

Hirotake KANEKO

April 5/2019April 5, 2019